

MMPQ2222

NPN Multi-Chip General Purpose Amplifier

- This device is for use as a medium power amplifier and switch requiring collector currents up to 500mA.
- Sourced from process 19.



Absolute Maximum Ratings * T_a =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	30	V
V _{CBO}	Collector-Base Voltage	60	V
V _{EBO}	Emitter-Base Voltage	5.0	V
I _C	Collector Current - Continuous	500	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ +155	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

- These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charact	eristics	•			
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	$I_C = 10 \text{mA}, I_B = 0$	30		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 10\mu A, I_E = 0$	60		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_C = 10\mu A, I_C = 0$	5.0		V
I _{CBO}	Collector Cutoff Current	$V_{CB} = 50V, I_{E} = 0$		50	nA
I _{EBO}	Emitter Cutoff Current	V _{EB} = 3.0V, I _C = 0		50	nA
On Charact	eristics *				
h _{FE}	DC Current Gain	I _C = 10mA, V _{CE} = 10V I _C = 150mA, V _{CE} = 1.0V * I _C = 150mA, V _{CE} = 1.0V *	75 100 50		
V _{CE(sat)}	Collector-Emitter Saturation Voltage *	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$ $I_C = 500 \text{mA}, I_B = 50 \text{mA}$		0.4 1.6	V V
V _{BE(sat)}	Base-Emitter Saturation Voltage *	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$ $I_C = 500 \text{mA}, I_B = 50 \text{mA}$		1.3 2.6	V
Small Signa	Il Characteristics			1	
f _T	Current GAin Bandwidth Product	$I_C = 20 \text{mA}, V_{CE} = 20 \text{V},$ f = 100MHz		300	MHz
C _{obo}	Output Capacitance	$V_{CB} = 10V, I_E = 0, f = 100kHz$		4.0	pF
C _{ibo}	Input Capacitance	$V_{EB} = 0.5V$, $I_E = 0$, $f = 100kHz$		20	pF
NF	Noise Figure	$I_C = 100\mu A$, $V_{CE} = 10V$, $R_S = 1.0k\Omega$, $f = 1.0kHz$		2.0	dB

* Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%

Symbol	Parameter	Max.	Units
P_{D}	Total Device Dissipation	1000	mW
	Derate above 25°C	8.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		
	Effective 4 Die	125	°C/W
	Each Die	240	°C/W

Typical Characteristics

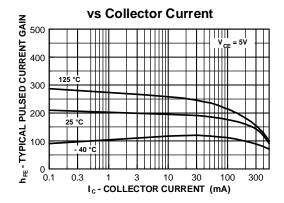


Figure 1. Typical Pulsed Current Gain vs Collector Current

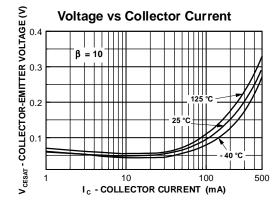


Figure 2. Collector-Emitter Saturation Voltage vs Collector Current

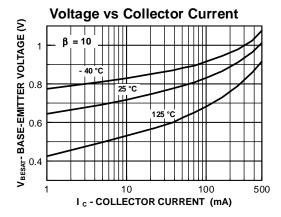


Figure 3. Base-Emitter Saturation Voltage vs Collector Current

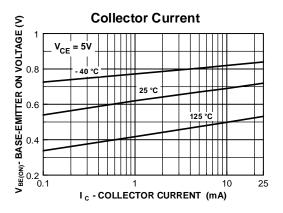


Figure 4. Base-Emitter On Voltage vs Collector Current

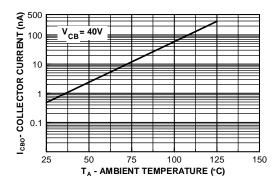


Figure 5. Collector Cutoff Current vs Ambient Temperature

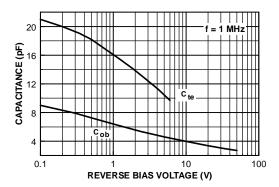


Figure 6. Emitter Transition and Output Capacitance vs Reverse Bias Voltage

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Typical Characteristics (Continued)

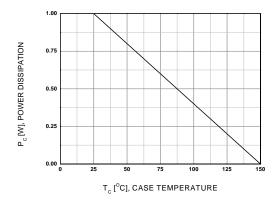
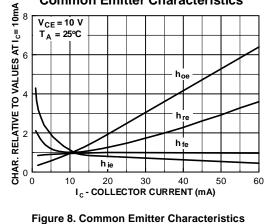


Figure 7. Power Dissipation vs **Ambient Temperature**



Common Emitter Characteristics

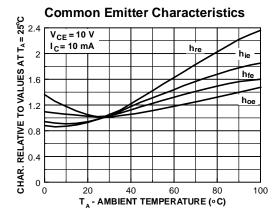


Figure 9. Common Emitter Characteristics

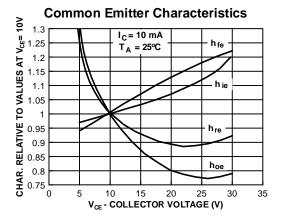


Figure 10. Common Emitter Characteristics

Test Circuit

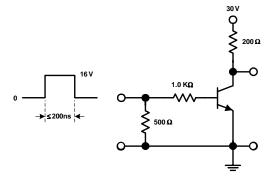


Figure 1. Saturated Turn-On Switching Time

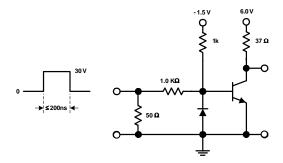
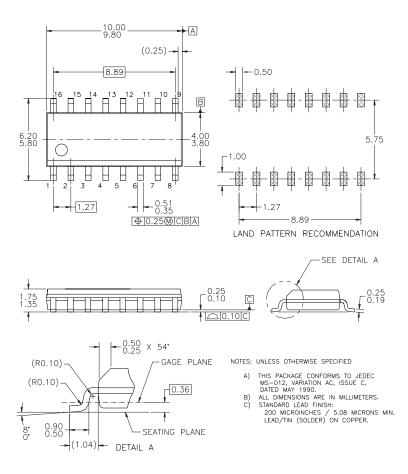


Figure 2. Saturated Turn-Off Switching Time

Package Dimensions

SOIC-16



Dimensions in Millimeters

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